

Datasheet revision 1.0

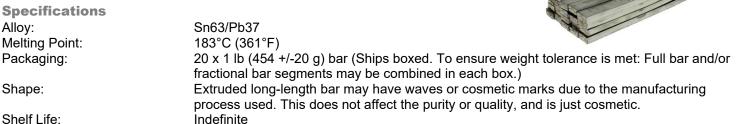
Super Low Dross[™] Solder Bar Sn63/Pb37 20lb (9.08kg) Extruded Long-Length

EXLB-SN63PB37-20LB

www.chipquik.com

Product Highlights

Extruded Long-Length High Reliability Solder Bar Manufactured Specifically for High Quality Electronics Manufacturing (EMS, ECM, OEMs) Designed for Solder Pots, Wave Solder Machines and Selective Solder Machines Chip Quik® Super Low Dross™ Solder Bar is Ideal for Through Hole and Surface Mount Soldering **High Purity**



Shelf Life:

Purity

Element	IPC J-STD-006C	ChipQuik® Super Low Dross™ SN63PB37
Silver (Ag)	0.100 %	< 0.100 %
Aluminum (Al)	0.005 %	< 0.005 %
Arsenic (As)	0.030 %	< 0.030 %
Gold (Au)	0.050 %	< 0.050 %
Bismuth (Bi)	0.100 %	< 0.100 %
Cadmium (Cd)	0.002 %	< 0.002 %
Copper (Cu)	0.080 %	< 0.080 %
Iron (Fe)	0.020 %	< 0.020 %
Indium (In)	0.100 %	< 0.100 %
Nickel (Ni)	0.010 %	< 0.010 %
Lead (Pb)	0.070 %	37.000 %
Tin (Sn)	0.250 %	63.000 %
Zinc (Zn)	0.003 %	< 0.003 %
Antimony (Sb)	0.200 %	< 0.200 %

Tolerances: +/-0.100% (Composition ≤ 1.000%), +/-0.200% (1.000% < Composition ≤ 5.000%), +/-0.500% (Composition > 5.000%)

Storage and Handling Store in a dry non-corrosive environment.

Transportation

Tost Posults

This product has no shipping restrictions.

Test J-STD-004 or other requirements as stated	Test Requirement	Result
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains Lead (Pb) CAS# 7439-92-1 No other SVHC present

Conforms to the following Industry Standards: J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): RoHS 3 Directive (EU) 2015/863:

Yes No [Contains Lead (Pb)]